

# Statistical Coverage in SI System Simulations and Implications for Models

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# Agenda

- What You Should Take Away
- The Challenge of Complete Coverage
- Using Statistics to Improve Coverage
  - One Approach: Response Surface Modeling
- Using Statistics to Assess Risk
  - One Approach: DPM
- Implications for the IBIS Community
- Summary
- References
- Q & A

Thanks to Tommy Cheung of Intel for significant source material



# Caution!

The word “**statistics**” here does not refer to analysis of SerDes buffer data processing algorithms or performance

Here, “**statistics**” refers to the broader science of using numerical data to make statements or inferences about groups



# What You Should Take Away

Designers, model makers, etc. need to understand where statistical assumptions are made

Statistics can be used to maximize efficiency in design

- This covers both analysis time and design cost

Avoiding statistics can cause over-design or under-design

For complete, informed SI coverage, consider making explicit use of several statistical concepts...

- Parameter distributions (e.g., PCB impedance in volume manufacturing)
- Defect tolerances
- Confidence levels

The IBIS community should encourage and design for use of statistical concepts and data

# Review: Objectives of SI Simulation

Generally, signal integrity (SI) simulations are performed to:

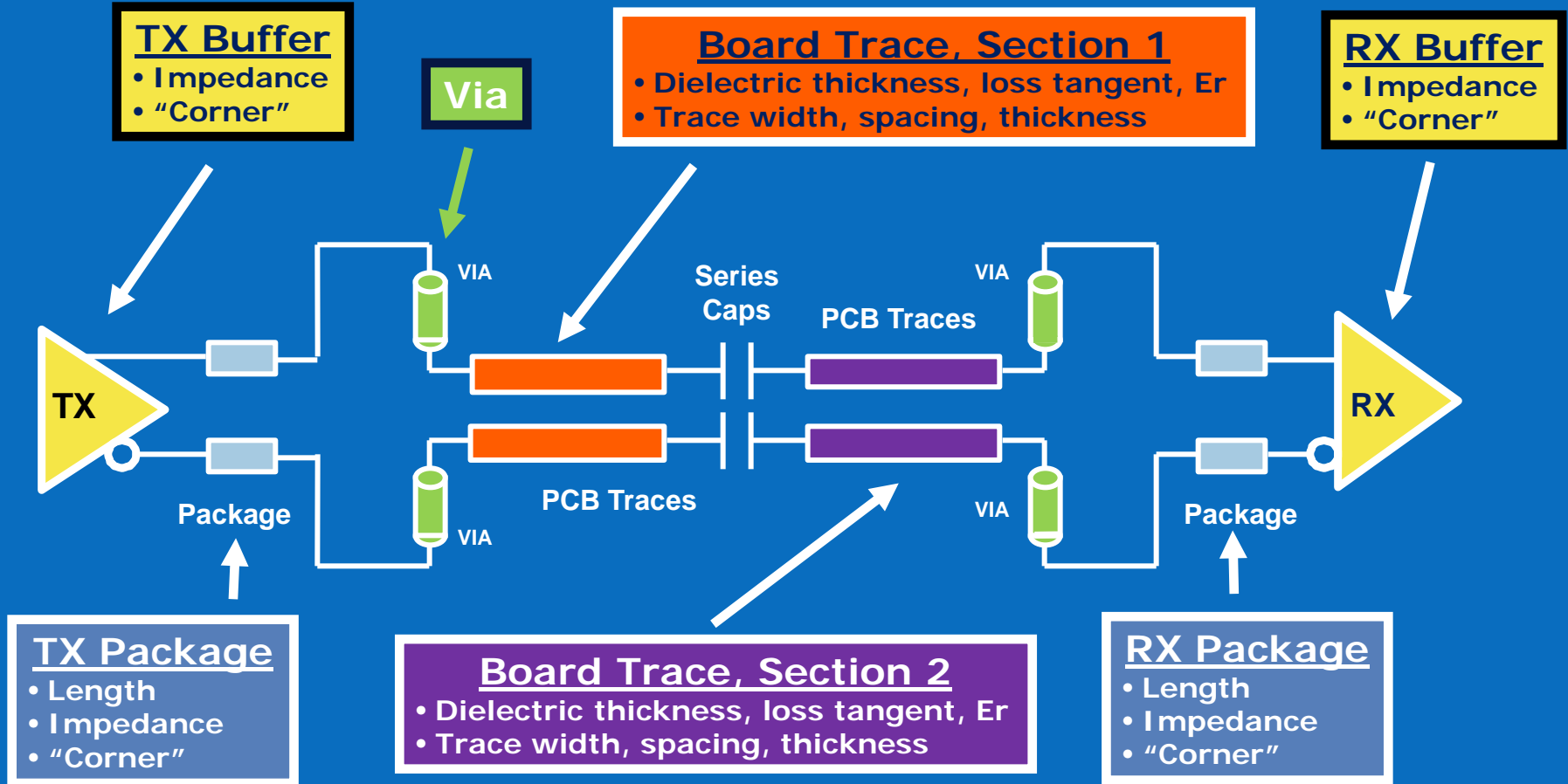
- Characterize or establish the sensitivity of analog signal quality outputs or goals to design parameters
  - *e.g., how long can my traces get before the signal vanishes?*
- Find the worst-case topology or design situation in a platform
  - *“Worst-case” can refer to many outputs: timing, voltage, etc.*

Customers often have multiple goals

- Ensure positive margins across the design & manufacturing
- Perform cost reductions or optimizations

Simulations mean modeling the system response to establish input-output relationships, then examining or testing those relationships

# Design Parameters in a SerDes System



Note the number of parameters. How do you cover all these?  
How do you determine formal relationships between inputs and outputs?



# Investigating a SerDes Solution Space

Design Parameter	Specific Variations
<b>Transmitter</b>	
Termination Resistance	3
Termination Capacitance	3
<b>Receiver</b>	
Termination Resistance	3
Termination Capacitance	3
<b>Transmitter Package</b>	
Routing Length	3
Differential Impedance	3
<b>Receiver Package</b>	
Routing Length	3
Differential Impedance	3
<b>Trace Cross-Section</b>	
Section 1 Dielectric Constant	3
Section 1 Loss Tangent	3
Section 1 Trace Width	3
Section 1 Within-pair Spacing	3
Section 1 Pair-to-pair Spacing	3
Section 2 Dielectric Constant	3
Section 2 Loss Tangent	3
Section 2 Trace Width	3
Section 2 Within-pair Spacing	3
Section 2 Pair-to-pair Spacing	3
<b>Routing</b>	
Section 1 Length	3
Section 2 Length	3

Specific variations are the values each parameter can take in a simulation

For example

Dielectric range = 3 – 4 mils

3 variations in that range = 3.0, 3.5, 4.0

Exhaustive simulation means covering every combination (variation \* variation \*...)

59,049

# Investigating the Solution Space

Design Parameter	Specific Variations
<b>Transmitter</b>	
Termination Resistance	3
Termination Capacitance	3
<b>Receiver</b>	
Termination Resistance	3
Termination Capacitance	3
<b>Transmitter Package</b>	
Routing Length	3
Differential Impedance	3
<b>Receiver Package</b>	
Routing Length	3
Differential Impedance	3
<b>Trace Cross-Section</b>	
Section 1 Dielectric Constant	3
Section 1 Loss Tangent	3
Section 1 Trace Width	3
Section 1 Within-pair Spacing	3
Section 1 Pair-to-pair Spacing	3
Section 1 Dielectric Constant	3
Section 2 Loss Tangent	3
Section 2 Trace Width	3
Section 2 Within-pair Spacing	3
Section 2 Pair-to-pair Spacing	3
<b>Routing</b>	
Section 1 Length	3
Section 2 Length	3

Exhaustive or “grid” simulation covers every case

Permitting variations to cover minimum, typical and maximum *values* for each parameter results in...

**3.48 billion simulations**

This is not a complete or sufficient list... and the ranges themselves may require iteration

Exhaustive simulation is impossible.  
Even grid simulation doesn't establish relationships.

Is there a better way?



# Finding Relationships with Few Cases

Problem: too many cases for unknown relationships

- Exhaustive simulation takes too much simulation time and resources
- Random simulations or guesses can miss critical behaviors and may not rigorously define relationships – this makes predictions difficult!

Solution: Use statistical methods

- One method: Response Surface Modeling (RSM) – see references
- Select cases and create a predictive model using least-squares fitting

Advantages of Statistical Methods Like RSM

- Well-known: used in manufacturing and the social sciences
- Efficient: can reduce simulation burden significantly
- Predictive: you get definitive, mathematical relationships
- Comprehensive: more than just a one-dimensional sensitivity analysis
- Quantify risk: provide explicit confidence levels

A second-order fit of 20 variables can reduce coverage burden from 3.48 billion cases to 256 cases

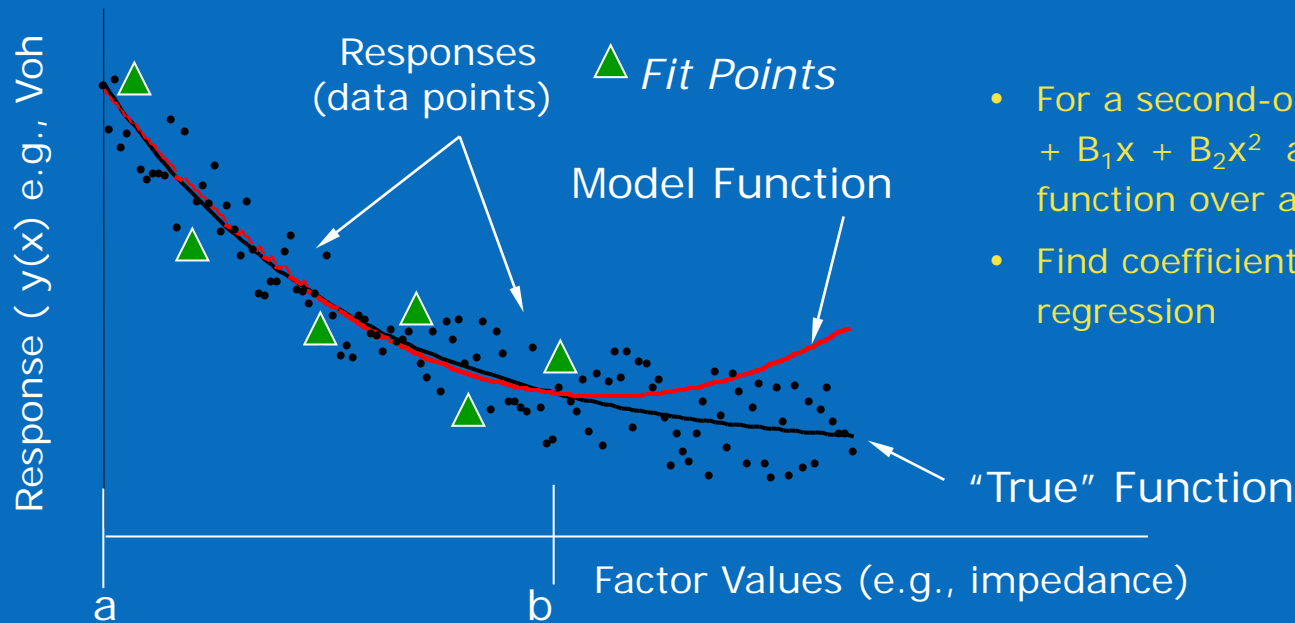


# Empirical Modeling

Replaces a complicated analytic response function with a simpler *empirical* function of the input variables

Predicts the response for given factors without re-running simulations

Significance of the results can be evaluated from statistics on the fit



- For a second-order fit, model  $F(x) = B_0 + B_1x + B_2x^2$  approximates the true function over a limited range
- Find coefficients ( $B_i$ ) using least squares regression

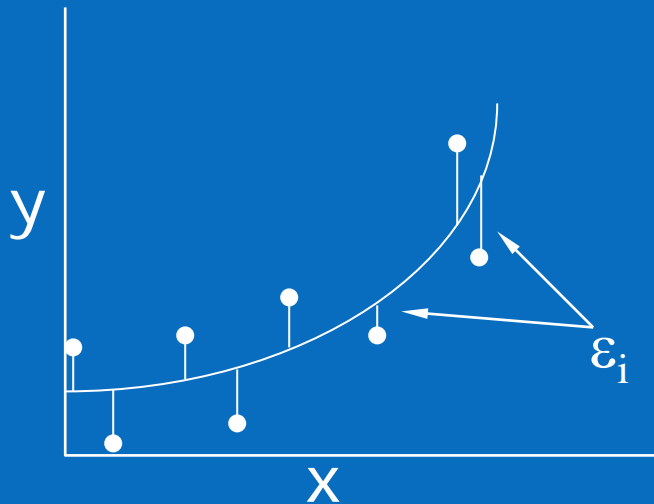
Fit a simpler statistical model to data from a more complex analytic SI computer model (e.g., SPICE)

# Case Inputs and Evaluating Outputs

Cases are selected based on assumed fit relationship

- Select the input parameters and combinations to run based on fit needs
- Engineering judgment and screening runs are critical here

Quality of fit statistics indicate quality of assumptions about fit relationship and input parameters



Some example fit quality checks:

**Residuals:** Difference between actual and predicted results

**Rsqr:** How much of the output variation is explained by input variations?

**RMSE:** Root Mean Squared Error – RMS value of predicted vs. actual error

Statistics texts provide many others...

Outcome is a simplified “model of a model” with known quality assessments and confidence intervals for the fit

# How Can We Use the Model-of-a-Model?

RSM provides a simplified set of equations that predicts the system behavior

This is essentially a “simulator in a spreadsheet”

- Equations could be large and/or complex
- Quicker with faster computers and more capable math tools

We can then make fast “what-if” predictions within the valid ranges of this set

- Simulate large numbers of cases – potentially millions
- Examine non-uniform variations in input and resulting outputs (e.g. Monte Carlo)

Results approximate output of full simulations

- As accurate as the original prediction fits were accurate

Relatively few simulations can generate millions of results



# RSM -> Prediction-Based Monte Carlo

## Monte Carlo

## Prediction Formulas

	DIMM1_ER	CSPkg_TRWIDTH	MB_TR_WIDTH	MB_SP	MBBrk2CHA_LENGTH	Pred Formula Voh	Pred Formula Total Derated System Skew
1	3.81749905	29.9286732	5	20	4.7	0.97111463	-0.2191045
2	4.14071353	26.8277443	6.66666667	18.33333333	0.9	1.03127234	-0.2472544
3	4.06055011	27.6148573	6.66666667	18.33333333	3.2	1.0196399	-0.2501578
4	3.81029692	26.0763189	5	20	3.15	0.98158417	-0.253558
5	3.97294708	28.4427032	5	20	0.8	1.00961271	-0.2421223
6	4.21150309	29.5636414	8.33333333	16.66666667	2.55	1.00643079	-0.2442386
7	3.93506332	27.9611728	10	15	4.4	1.02940844	-0.2715204
8	4.06282691	30.0494808	5	20	4.8	0.99547099	-0.259795
9	4.01186288	25.9681414	10	15	3.3	1.03314472	-0.2503127
10	4.00780808	30.9832494	6.66666667	18.33333333	3.7	0.9962155	-0.2289716



Millions of cases

Use RSM formulas in spreadsheet-style analyses to...

- Examine new situations not simulated
- Find minor max margins (worst/best case)



# The Problem of Worst Case Analysis

Worst-case analysis or design assumes

- All parameters have an equal likelihood of being at the extremes of their ranges at any given time
- Therefore, design for positive margins where a system has all parameters at the extremes *simultaneously*...
- ... regardless of how likely that is!

Parameter	Min	Typ	Max	Units
TX Resistance	75	85	95	$\Omega$
TX Capacitance	0.85	1.00	1.15	pF
Board 1 Trace Impedance	72.25	85	97.75	$\Omega$
Board 2 Trace Impedance	72.25	85	97.75	$\Omega$
RX Resistance	75	85	95	$\Omega$
RX Capacitance	0.7	0.8	0.9	pF

Parameter	Min	Typ	Max	Units
TX Resistance	75	85	95	$\Omega$
TX Capacitance	0.85	1.00	1.15	pF
Board 1 Trace Impedance	72.25	85	97.75	$\Omega$
Board 2 Trace Impedance	72.25	85	97.75	$\Omega$
RX Resistance	75	85	95	$\Omega$
RX Capacitance	0.7	0.8	0.9	pF

As likely  
as this  
situation?

Or this?





# The Statistical Problem

In simulation, every parameter is known and controllable for any given system

In manufacturing, few parameters are known or controllable for any given system

- But the behavior of the *whole population* of cases is predictable *statistically by sampling*

Faster interfaces are now fault-tolerant

- e.g., BER = bit *error* rate – data errors are expected!
- The only way to predict or analyze this is through statistics

Statistical simulation predicts what design parameters affect the likelihood of errors

**Modern designs limit errors, instead of eliminating them.  
Design teams and their management must get  
comfortable with *using* this concept!**



# DPM Concepts

DPM = Defects Per Million

- Of every million units, how many do not meet requirements?
  - *“Unit” can be a single parameter instance instead of an entire physical object or product*
- A statistical metric for a process
- Useful (and used) in manufacturing

DPM assumes...

- Some number of units will fail to satisfy a given criterion
- Parameters of interest have distributions (e.g., normal, uniform)
- Probabilities are involved
  - *Characterize populations by analyzing representative samples*

DPM goes beyond absolute worst-case!

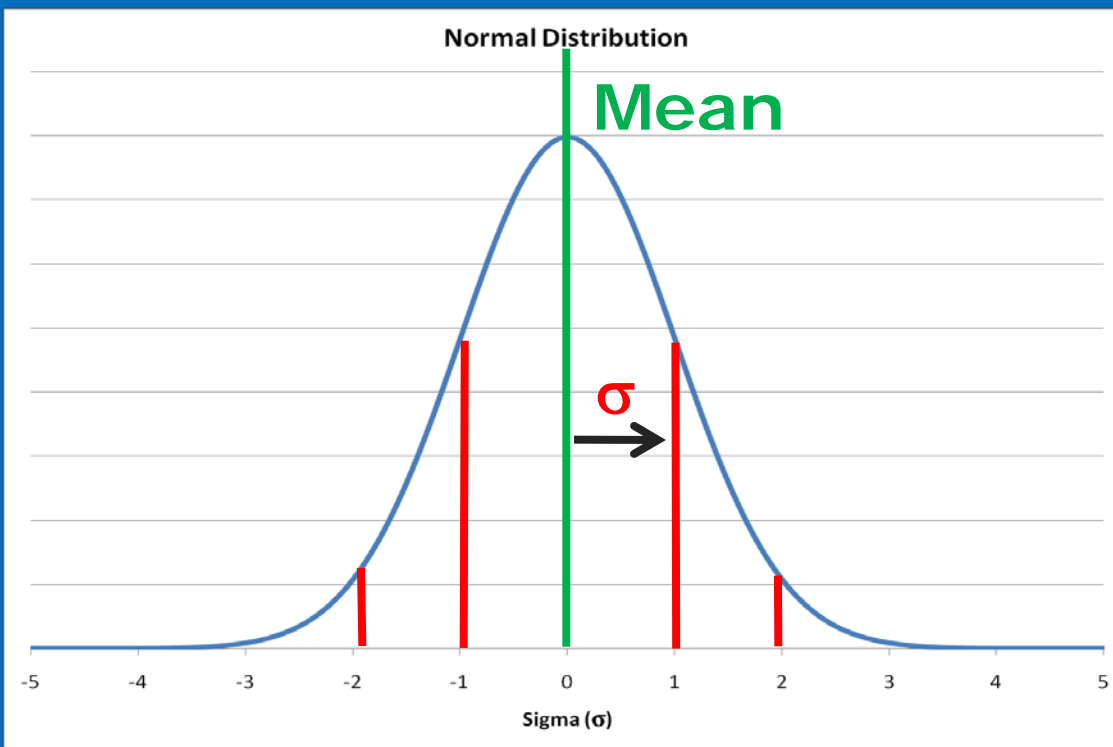


# Lightning Probability Review

Mean ( $\mu$ ) – average or sum of all measurements divided by the number of measurements

- For a normal distribution, the **mean** is also the **mode** or most often occurring value

Standard deviation ( $\sigma$ ) – indication of the width or distribution of values within the curve



Each  $\sigma$  away from mean covers a fixed portion of the distribution...

$$\pm 1 \sigma = 68.27\%$$

$$\pm 2 \sigma = 95.45\%$$

$$\pm 3 \sigma = 99.73\%$$

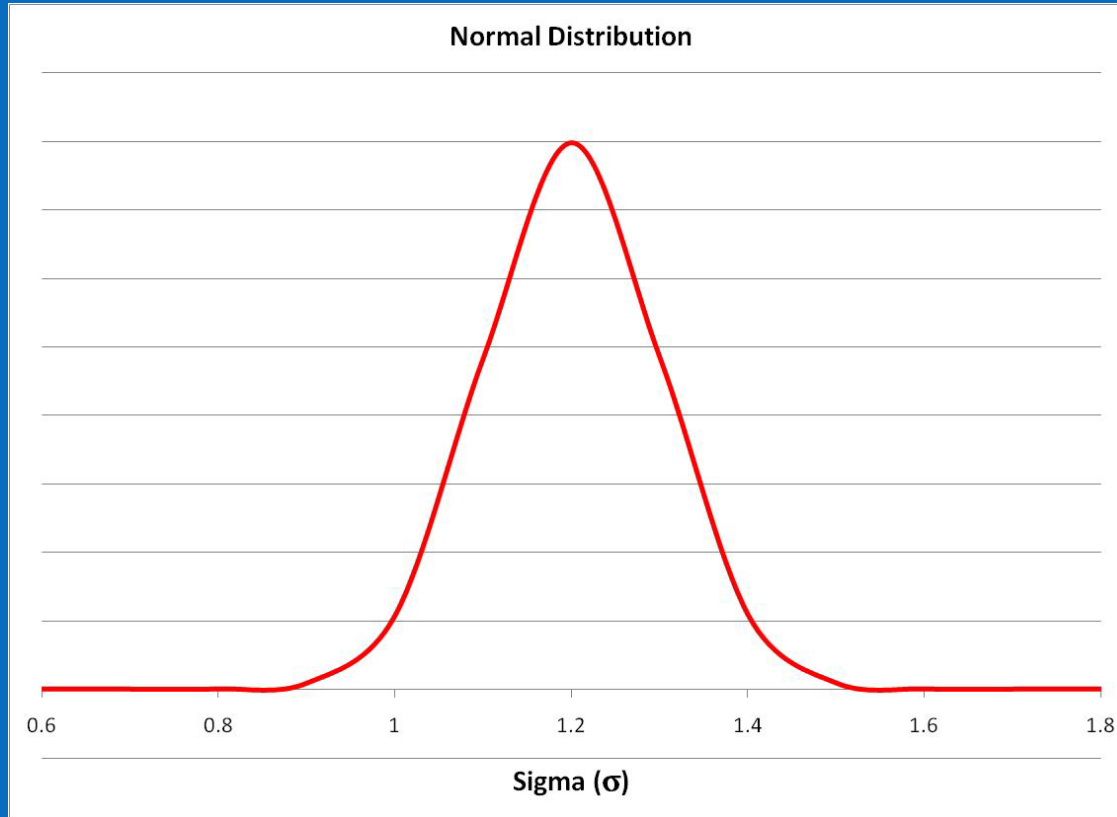
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$$\pm 6 \sigma = 99.999...\%$$

# A DPM Example

A factory making paper clips...

- The metal in the clips must be larger than a certain diameter to



On average, the clips are 1.2 mm in diameter

95% of them are within 0.2 mm of the average diameter

Of every million clips, how many will not meet the specification?

# DPM Calculation

DPM is calculated using the Cumulative Distribution Function (CDF)

- The CDF is the number of units under the probability density curve within a given range

For a single parameter, with a normal distribution...

- Expected value or mean of  $\mu$
- Standard deviation of  $\sigma$
- Lower specification limit of LSL

$$D_{ppm} = 1,000,000 * \frac{1 + \operatorname{erf}\left[\frac{(LSL - \mu)}{\sigma\sqrt{2}}\right]}{2}$$

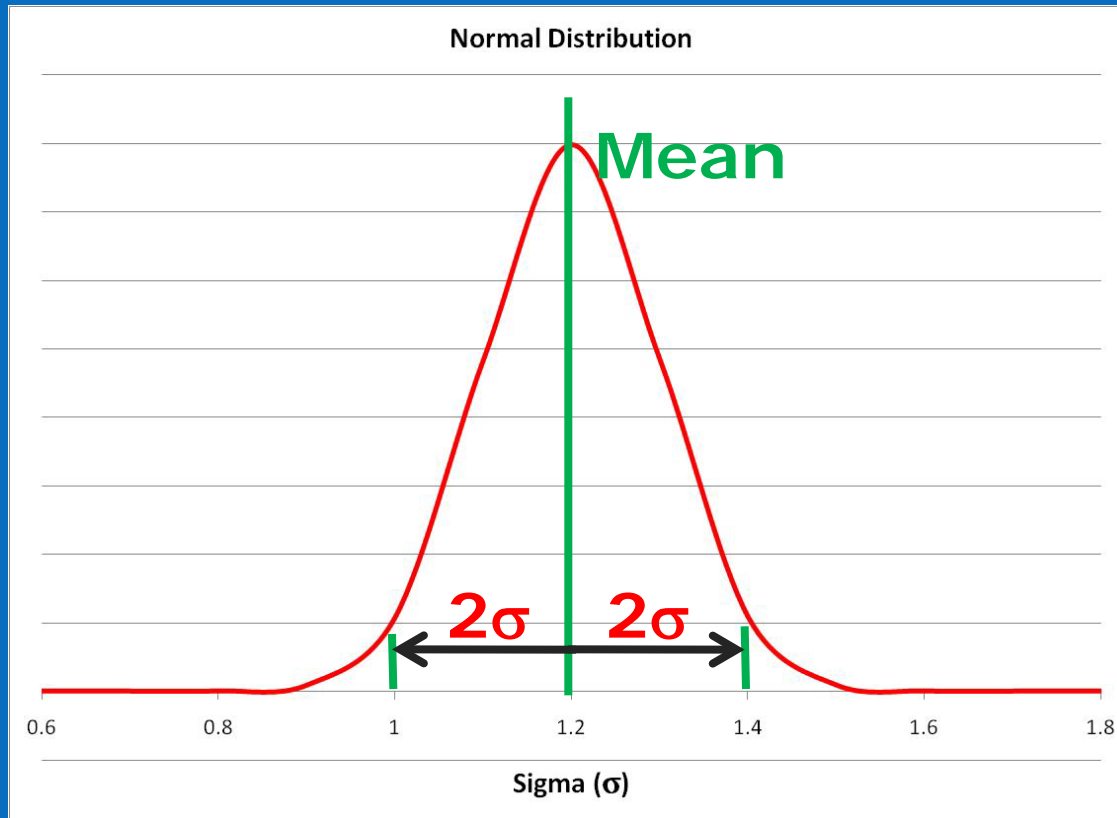
- Hall/Heck, p. 630 (equation has incorrect division by 1e6)
- This can be calculated in Microsoft Excel\* using NORMDIST
  - $=\text{NORMDIST}(LSL, \mu, \sigma, \text{TRUE}) * 1000000$
- Other tools usually have similar functions



# Applying DPM to an Example

A factory making paper clips...

- The metal in the clips must be larger than a certain diameter to prevent breaking (say 0.8 mm)



$$\mu = 1.2 \text{ mm}$$

$2 \sigma = 0.2 \text{ mm}$   
(95% are within  
0.2 mm)

$$\sigma = 0.1 \text{ mm}$$

Of every million  
clips, how many  
are below 0.8 mm  
in diameter?

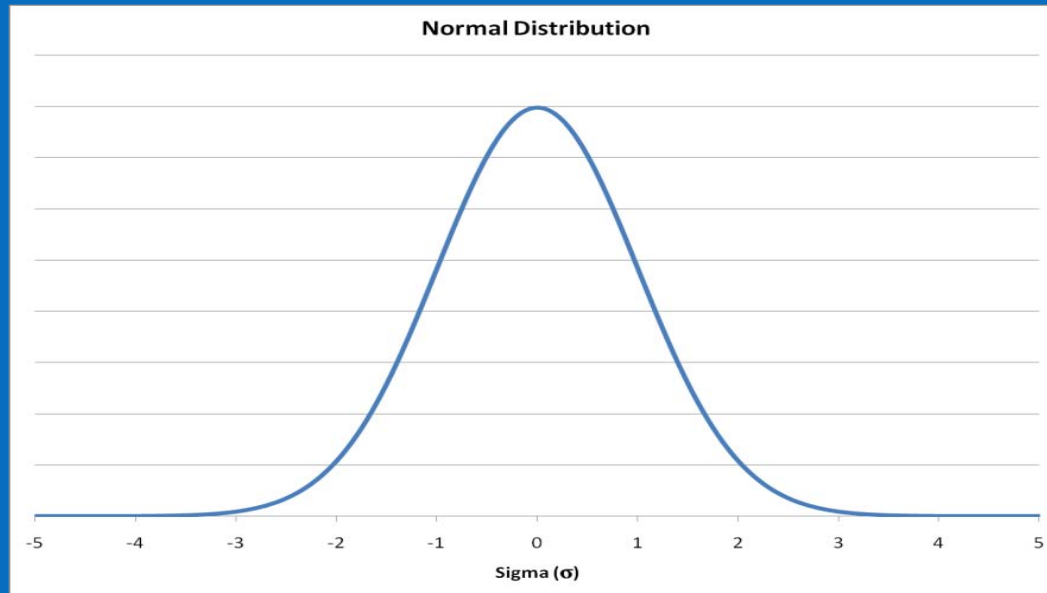
$$\text{DPM} = 32$$

# Applying DPM

Manufacturing must assume some DPM

Many/most processes in nature and manufacturing are normal

- Follow the normal or Gaussian probability distribution "bell curve"



How many DPM is acceptable *depends...*

- e.g., for hard drive mechanical components, a DPM of 150 may result in customer calls to the CEO
  - Wayne Fortun, CEO, Hutchinson Technology - July 10, 2009, Boston

# Putting RSM and DPM Together...

You can calculate DPM from RSM model fits

- Fit the model and obtain the RSM prediction formulae
- Set the distributions on the input parameters
- Run a statistical analysis on 1 million cases
- Examine the output (e.g., eye height, eye width)
- Number of cases violating your requirement = DPM

Available statistical tools should have this capability

	DIMM1_ER	CSPkg_TRWIDTH	MB_TR_WIDTH	MB_SP	MBBrk2CHA_LENGTH	Pred Formula Voh	Pred Formula Total Derated System Skew
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1e6

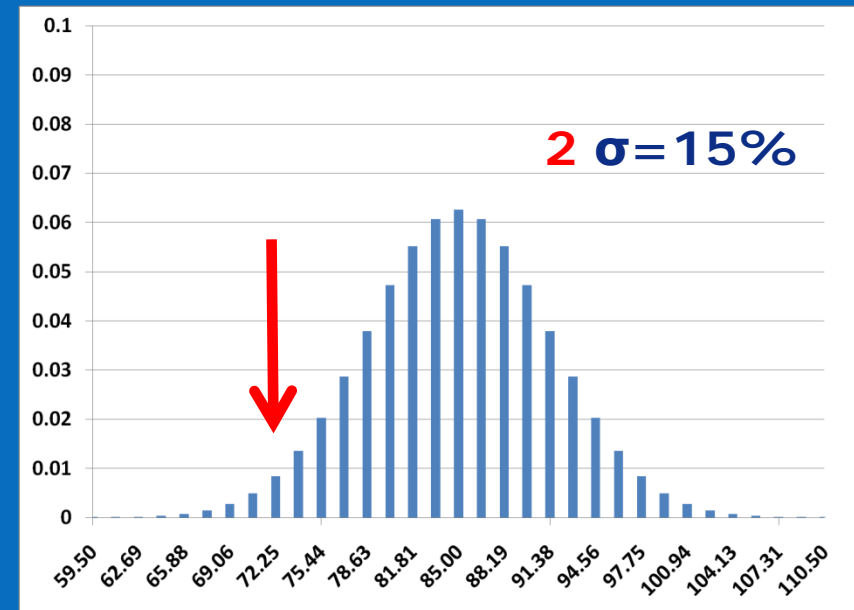
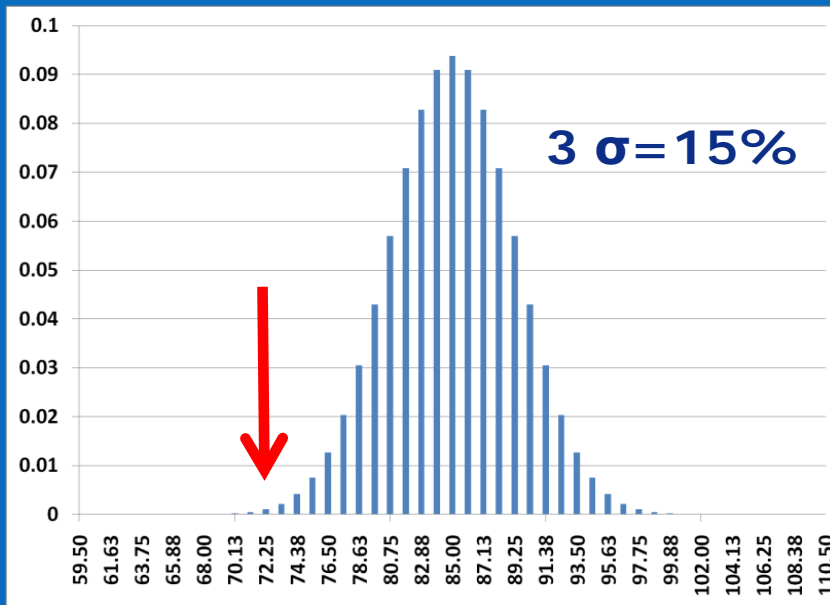




# Impact of Statistics

An example using PCB impedance and tolerance

- Assume a differential target of  $85\ \Omega \pm 15\%$
- How many sigma does " $\pm 15\%$ " represent in production?
- What  $\sigma$  should I use in simulation? Does it vary per manufacturer?
- How probable is seeing a board impedance of  $72.25\ \Omega$ ?
  - *8 times more likely at  $2\sigma = 15\%$  than  $3\sigma = 15\%$  (normal dist.)*
  - *If  $72.25$  is my design limit, which manufacturer is more risky?*



# Implications for the IBIS Community

How useful is the concept of “corner” in a statistical sense?

- Is the IBIS approach of using “typ/min/max” *categories* granular enough for statistical analysis?
- Should we consider variable numeric parameters instead?

If you produce and/or release models, are they configured to allow statistical variation?

- Applies especially to buffers, packages and PCB traces

Are you prepared to use and/or support statistical design inputs and evaluation criteria (e.g., DPM)?

Do you currently support statistical analysis in what you provide to your customers and partners? In your design flow?



# Summary

Designers, model makers, etc. need to understand where statistical assumptions are made

Statistics can be used to maximize efficiency in design

- This covers both analysis time and design cost

Avoiding statistics can cause over- or under-design

For complete, informed SI coverage, consider making explicit use of several statistical concepts...

- Input distributions (e.g., PCB Z in volume manufacturing)
- Defect tolerances
- Confidence levels

The IBIS community should encourage and design for use of statistical concepts and data



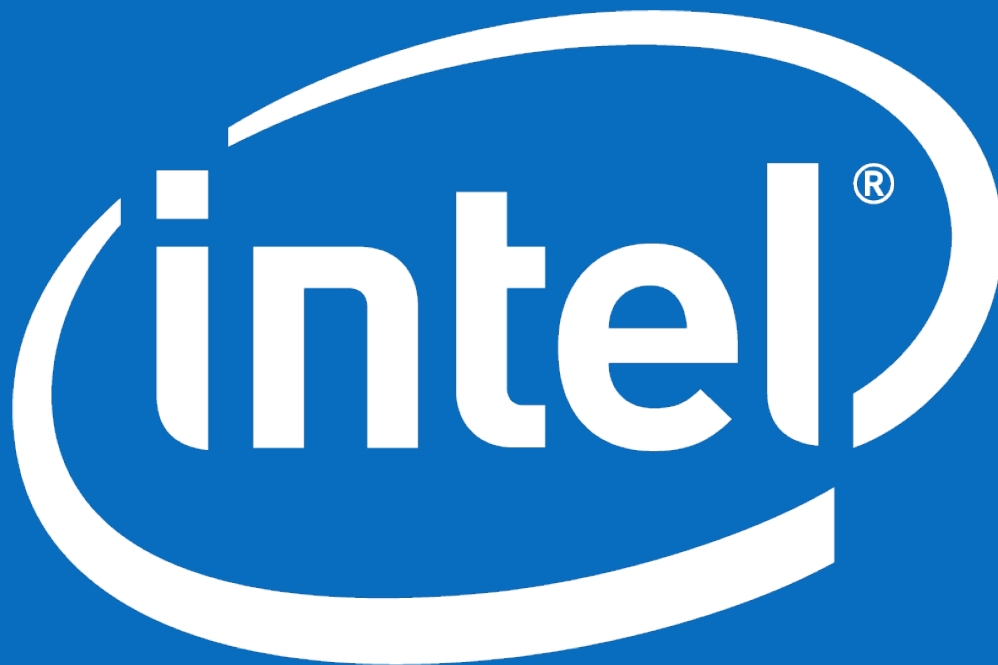
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- Hamming, R.W., *Numerical Methods for Scientists and Engineers*, 2nd ed., 1986: Dover
- Meyers, Raymond H., and Montgomery, Douglas C., *Response Surface Methodology: Process and Product Optimization Using Designed Experiments*, 1995: J.W. Wiley
- Many books, particularly on “Six Sigma” management techniques are available



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